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FCP16N60 / FCPF16N60 N-Channel SuperFET[®] MOSFET **600 V, 16 A, 260 m**Ω

Features

- 650V @ T_J = 150°C
- Typ. R_{DS(on)} = 220 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 55 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 110 pF)
- · 100% Avalanche Tested

Applications

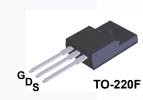
- Solar Inverter
- · AC-DC Power Supply

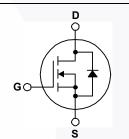
FCP16N60 / FCPF16N60 — N-Channel SuperFET[®] MOSFET

Description

SuperFET[®] MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low onresistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.







Absolute Maximum Ratings

Symbol		Parameter		FCP16N60	FCPF16N60	Unit
V _{DSS}	Drain-Source Voltage			6	V	
I _D	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		16 10.1	16* 10.1*	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	48	48*	А
V _{GSS}	Gate-Source Voltage			±	V	
E _{AS}	Single Pulsed Avalanche Energy			4	mJ	
I _{AR}	Avalanche Current		(Note 1)	16		А
E _{AR}	Repetitive Avalanche Energy		(Note 1)	20.8		mJ
dv/dt	Peak Diode Recov	/ery dv/dt	(Note 3)	4.5		V/ns
P _D	Power Dissipation	(T _C = 25°C) - Derate Above 25°C		167 1.33	37.9 0.3	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range		-55 to	°C		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			3	°C	

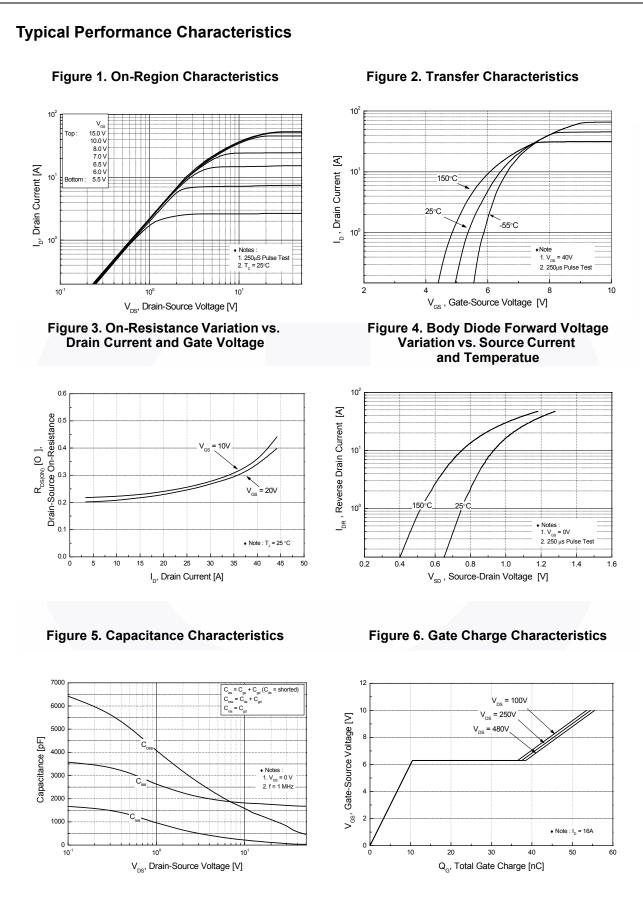
*Drain current limited by maximum junction temperature.

Thermal Characteristics

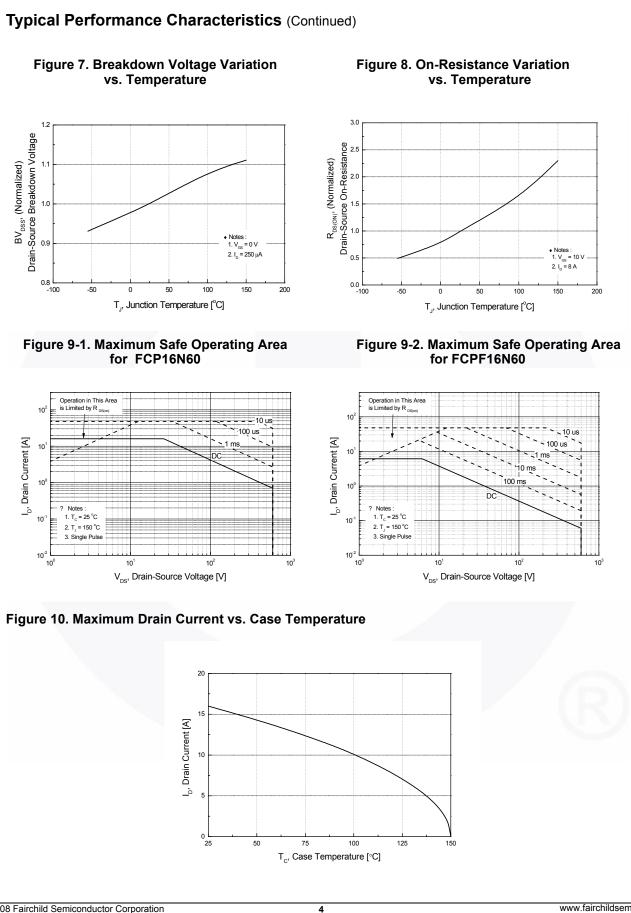
Symbol	Parameter	FCP16N60	FCPF16N60	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.75	3.3	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

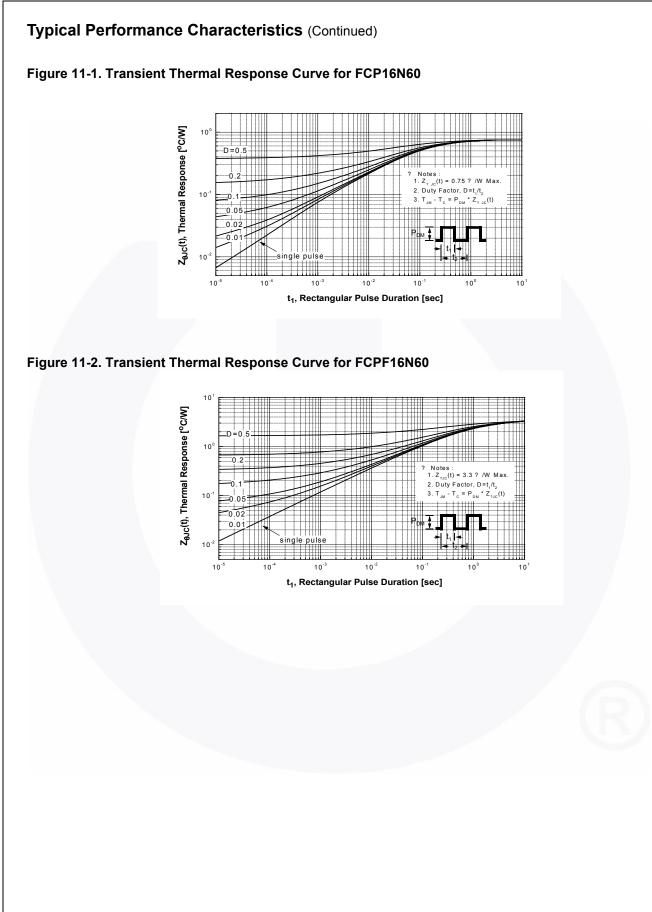
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FCP16N FCPF16 Electrica	N60	FCP16N60 FCPF16N60	TO-2	20	Tube	N/A		N/A	50 1	units
		FCPF16N60	TO-22					IN/A	50 0	annto
Electrica				-220F Tube N/A			N/A		50 units	
	l Chara	acteristics $T_c =$	25ºC unle	ss oth	nerwise noted.					
Symbol		Parameter			Test Conditio	ons	Min.	Тур.	Max.	Unit
Off Charac	teristics	5								
	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient			$\begin{split} I_D &= 250 \; \mu \text{A}, \; \text{V}_{\text{GS}} = 0 \; \text{V}, \; \text{T}_{\text{J}} = 25^{\text{o}}\text{C} \\ I_D &= 250 \; \mu \text{A}, \; \text{V}_{\text{GS}} = 0 \; \text{V}, \; \text{T}_{\text{J}} = 150^{\text{o}}\text{C} \end{split}$			600	-	-	V
3V _{DSS}							-	650	-	V
ΔBV _{DSS} ΄ ΔΤ _J				$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$		-	0.6	-	V/ºC	
BV _{DS}	Drain-Source Avalanche Breakdown Voltage		down	V _{GS} = 0 V, I _D = 16 A		-	700	-	V	
I _{DSS}	Zero Gate Voltage Drain Current		nt		$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	1	μA
033				V _{DS} = 480 V, T _C = 125 ^o C			-	-	10	
GSS	Gate to Body Leakage Current		_	Vo	V_{GS} = ±30 V, V_{DS} = 0 V		-	-	±100	nA
On Charac	teristics	5								
V _{GS(th)}	Gate Th	Gate Threshold Voltage		V _{GS} = V _{DS} , I _D = 250 μA			3.0	-	5.0	V
R _{DS(on)}	Static Dr	atic Drain to Source On Resistance orward Transconductance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$ $V_{DS} = 40 \text{ V}, \text{ I}_{D} = 8 \text{ A}$			-	0.55	0.26	Ω
9 _{FS}	Forward						-	11.5	-	S
Dynamic C	haracte	ristics								
C _{iss}		pacitance	-			-	1730	2250	pF	
C _{oss}	-	- Capacitance	_		$-V_{DS} = 25 V, V_{GS} = 0 V,$		-	960	1150	pF
C _{rss}		Transfer Capacitance		f = 1 MHz		-	85	-	pF	
C _{oss}		Capacitance			V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz		-	45	60	pF
C _{oss(eff.)}		Output Capacitance		$V_{\rm DS} = 0 \text{ V to } 400 \text{ V}, V_{\rm GS} = 0 \text{ V}$			-	110	-	pF
Q _g		te Charge at 10V	_		$V_{\rm DS} = 480 \text{ V}, \text{ I}_{\rm D} = 16 \text{ A},$		-	55	70	nC
Q _{gs}		Source Gate Charge		$V_{GS} = 10 V$		-	10.5	13	nC	
Q _{gd}		Drain "Miller" Charge		(Note 4)		-	28	-	nC	
ESR		valent Series Resistance		f = 1 MHz			-	1.7	-	Ω
Switching	Charact	oristics								1
							-	42	85	ns
t _{d(on)} t		n-On Delay Time n-On Rise Time				-	130	270		
t _r		Delay Time			$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 16 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 25 \Omega$		-		340	ns
t _{d(off)} t _f		Fall Time		•((Note 4)			165 90	190	ns ns
								50	100	113
		e Characteristics							10	
I _S		num Continuous Drain to Source Diode Forward Current				-		16	A	
I _{SM}		um Pulsed Drain to Source Diode Forward Current				-	-	48	A	
V _{SD}		Source Diode Forward	Voltage		$V_{GS} = 0 V, I_{SD} = 16 A$		-	-	1.4	V
t _{rr}		Recovery Time			$V_{GS} = 0 V, I_{SD} = 16 A,$		-	435	-	ns
Q _{rr}	Reverse	erse Recovery Charge		dI _F /dt = 100 A/µs		-	7.0	-	μC	

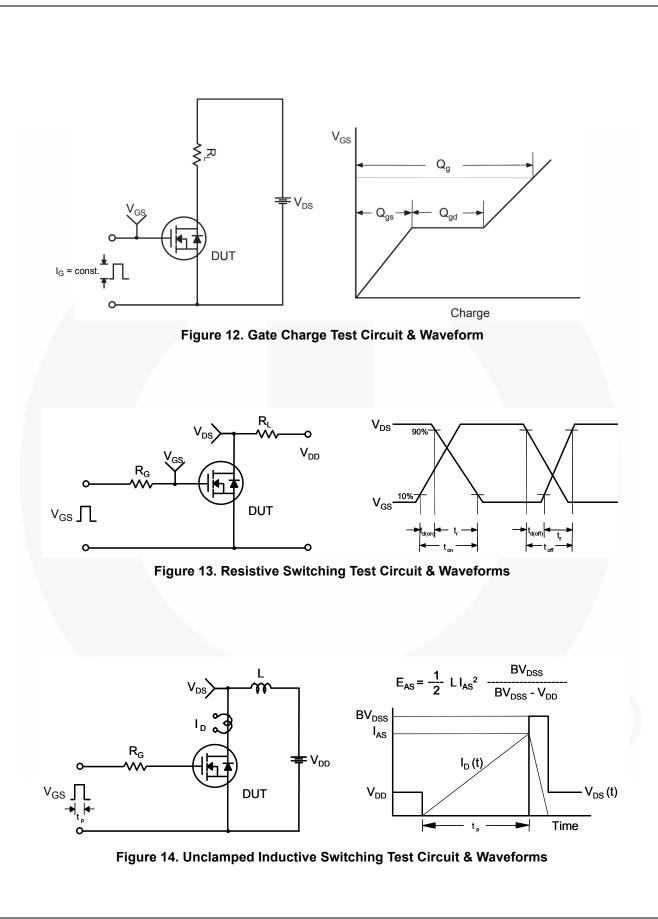


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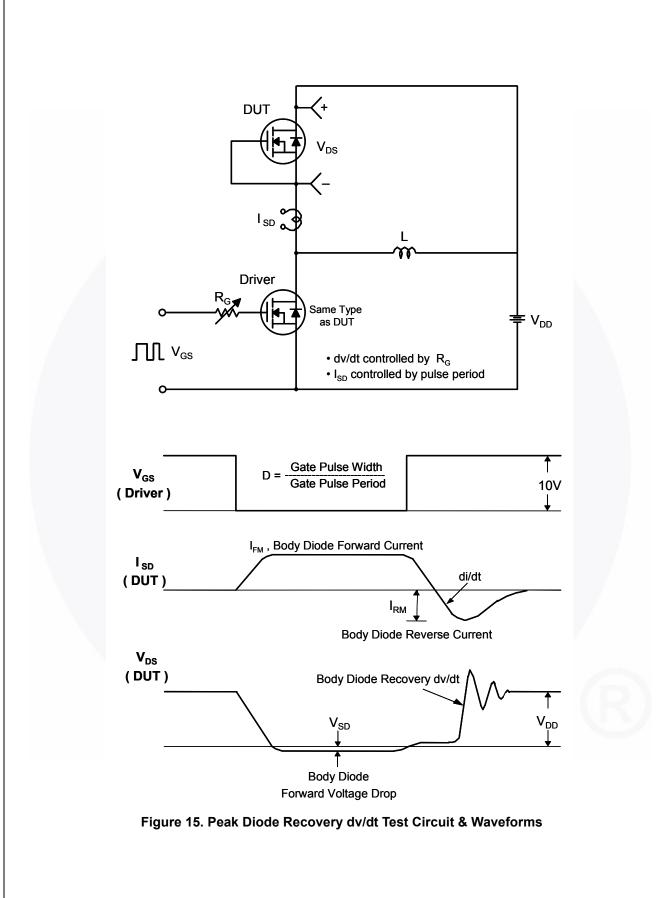


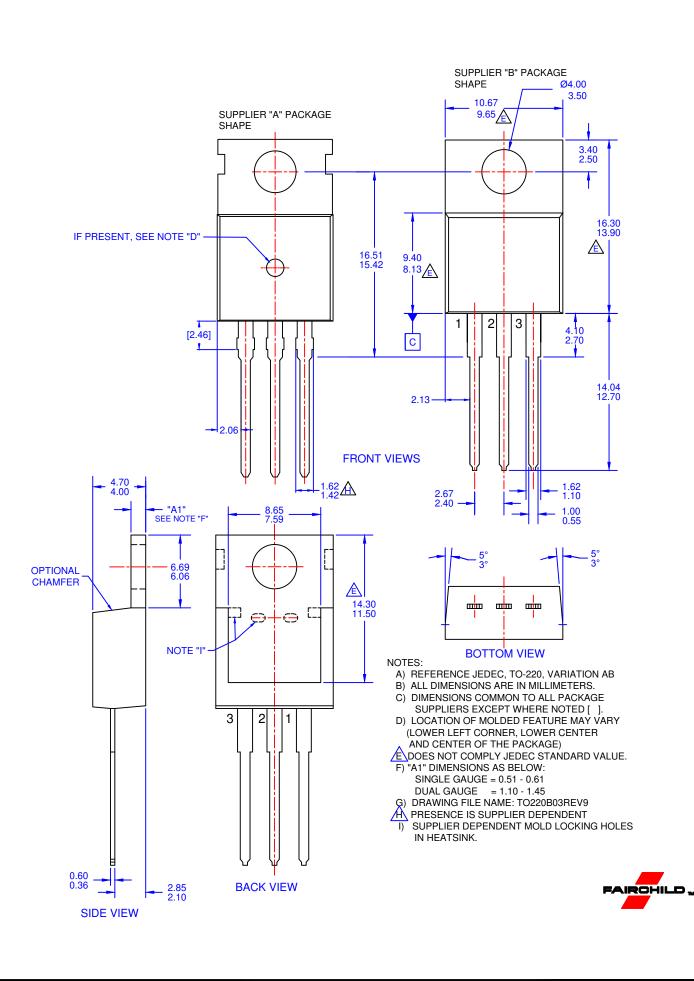
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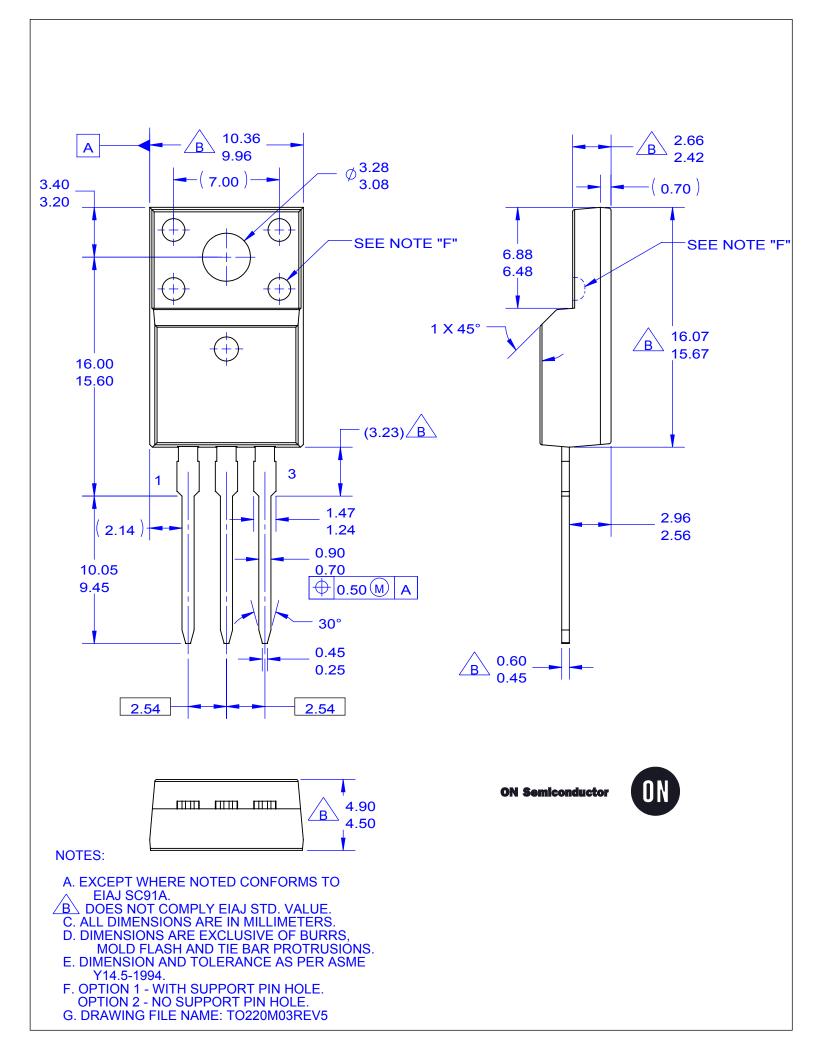


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FCP16N60 / FCPF16N60 — N-Channel SuperFET[®] MOSFET







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